L Number	Hits	Search Text	DB	Time stamp
-	821	216/27	USPAT;	2004/10/05 16:25
			US-PGPUB;	
			EPO; JPO;	·
			DERWENT;	
_	1205	29/890.1	IBM_TDB USPAT:	2004/10/05 16:23
-	1205	29/890.1	US-PGPUB;	2004/10/05 16:23
			EPO; JPO;	
			DERWENT;	;
			IBM_TDB	
-	374	438/21	USPAT;	2004/10/05 16:23
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
_	1747	347/20	IBM_TDB USPAT;	2004/10/05 16:28
	1		US-PGPUB;	2004/10/03 10.20
		·	EPO; JPO;	
			DERWENT;	
1			IBM_TDB	
_	1974	347/40	USPAT;	2004/10/05 16:28
			US-PGPUB;	,
1			EPO; JPO;	
			DERWENT; IBM TDB	
_	1086	347/44	USPAT;	2004/10/05 16:29
	1	· •	US-PGPUB;	2001, 20, 00 10.29
			EPO; JPO;	
	-		DERWENT;	
	0.156	247/47	IBM_TDB	
-	2459	347/47	USPAT;	2004/10/05 16:29
, '			US-PGPUB;	
			EPO; JPO; DERWENT;	
			IBM TDB	
_	1448	347/54	USPAT;	2004/10/05 16:29
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
_	1639	347/55	IBM_TDB	2004/10/05 16 66
	1039	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	USPAT; US-PGPUB;	2004/10/05 16:29
<i>f</i>			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
	1866	347/56	USPAT;	2004/10/05 16:29
		· ·	US-PGPUB;	
			EPO; JPO;	
			DERWENT; IBM TDB	
_	1871	347/65	USPAT;	2004/10/05 16:29
		• • • •	US-PGPUB;	2004/10/03 10.29
			EPO; JPO;	
			DERWENT;	
		247/60	IBM_TDB	
_	2488	347/68	USPAT;	2004/10/05 16:29
			US-PGPUB;	
			EPO; JPO; DERWENT;	
			IBM TDB	
_	1177	347/71	USPAT;	2004/10/05 16:29
			US-PGPUB;	,,
			EPO; JPO;	
			DERWENT;	
_	. 006	216/17	IBM_TDB	0004/10/05 15 05
_	- 806	216/17	USPAT;	2004/10/05 16:30
. 1			US-PGPUB; EPO; JPO;	
			DERWENT;	
			IBM TDB	,

		·		
_	521	216/39	USPAT;	2004/10/05 16:30
			US-PGPUB;	
1			EPO; JPO; DERWENT;	-
			IBM TDB	
	1558	216/41	USPAT;	2004/10/05 16:30
	1556	210/41	US-PGPUB;	2001, 10, 03 10.30
1			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
- '	205	216/46	USPAT;	2004/10/05 16:31
		·	US-PGPUB;	•
		,	EPO; JPO;	
		· ·	DERWENT; IBM TDB	·
	1521	438/700	USPAT;	2004/10/05 16:31
_	1321	438/700	US-PGPUB;	2004/10/03 10.31
			EPO; JPO;	
		·	DERWENT;	
			IBM_TDB	•
-	795	438/705	USPAT;	2004/10/05 16:32
,			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
-	540	438/740	IBM_TDB USPAT;	2004/10/05 16:34
_	546	430/140	US-PGPUB;	2007/10/03 10.34
			EPO; JPO;	
	-		DERWENT;	
			IBM TDB	
_	4243	(etch\$3 and silicon and (impurit\$3 or	USPĀT;	2004/10/05 16:58
		dop\$3 or implant\$3 or ion\$1) and	US-PGPUB;	
		(through-hole or opening or hole or	EPO; JPO;	
		passage\$3 or slot)).clm.	DERWENT;	
	1000	1 / 1 / 2 / 1 / 2 / 2 / 2 / 2 / 2 / 2 /	IBM_TDB	2004/10/05 16.40
_	1006	(etch\$3 and silicon and (impurit\$3 or	USPAT;	2004/10/05 16:40
		ion\$1) and implant\$3 and (through-hole or	US-PGPUB; EPO; JPO;	
		opening or hole or passage\$3 or slot)).clm.	DERWENT;	
		STOCY / CIM.	IBM TDB	. ,
	68	(216/27 or 438/21 or 438/21 or 347/20 orl	USPAT;	2004/10/05 16:42
		347/40 or 347/44 or 347/47 or 347/54 or	US-PGPUB;	
		347/55 or 347/56 or 347/65 or 347/68 or	EPO; JPO;	
		347/71) and (etch\$3 and silicon and	DERWENT;	
		(impurit\$3 or dop\$3 or implant\$3 or ion\$1)	IBM_TDB	
		and (through-hole or opening or hole or		
	133	passage\$3 or slot)).clm.	USPAT;	2004/10/05 16:52
-	133	(etch\$3 and silicon and (implant\$3 near3 ions) and (through-hole or opening or hole	US-PGPUB;	2004/10/03 10:32
		or passage\$3 or slot) and (arsenic or	EPO; JPO;	
		boron or phosphorus or antimony)).clm.	DERWENT;	•
1			IBM_TDB	
-	436	(etch\$3 and silicon and (implant\$3 near3	USPĀT;	2004/10/05 16:57
		ions) and (through-hole or opening or hole	US-PGPUB;	
		or passage\$3 or slot)).clm.	EPO; JPO;	
		•	DERWENT;	
_	110	(etch\$3 and silicon and (implant\$3 near3	IBM_TDB USPAT;	2004/10/05 16:57
	110	ions) and (through-hole or hole or	US-PGPUB;	2004/10/03 10:3/
		passage\$3 or slot)).clm.	EPO; JPO;	
	1		DERWENT;	
	1		IBM_TDB	
-	51	((ink\$1jet or printhead) and etch\$3 and	USPĀT;	2004/10/05 17:20
		silicon and (impurit\$3 or dop\$3 or	US-PGPUB;	
	1	implant\$3 or ion\$1) and (through-hole or	EPO; JPO;	
	1	opening or hole or passage\$3 or	DERWENT;	
_	10	slot)).clm.   (("6113222") or ("6128052") or ("6139761")	IBM_TDB USPAT;	2004/10/05 17:02
-	10	or ("6143190") or ("6305080")).PN.	US-PGPUB;	2004/10/03 17:02
	1	OF ( 01431)0 ) OF ( 0303000 )).FN.	EPO; JPO;	
	1		DERWENT;	
	1		IBM TDB	

_	248	438/700 or 438/705 or 438/740) and (etch\$3 and silicon and (impurit\$3 or dop\$3 or	USPAT; US-PGPUB; EPO; JPO;	2004/10/05 17:13
		<pre>implant\$3 or ion\$1) and (through-hole or opening or hole or passage\$3 or slot)).clm.</pre>	DERWENT; IBM_TDB	
_	37	1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/05 17:28
_	8	("4106976"   "4169008"   "4417946"   "4455192"   "4589952"   "4639748"   "4733823"   "4864329").PN.	USPAT	2004/10/05 17:21
-	30	5141596.URPN.	USPAT	2004/10/05 17:23
_	. 4	(("6554403") or ("20030202049")).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/05 17:28
-	2	"11204751"	JPO; DERWENT	2004/10/08 17:40
-	3	"2000021850"	JPO; DERWENT	2004/10/08 17:40

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